



### LOW CAPACITANCE BIDIRECTIONAL TVS DIODE

## **Product Summary**

V <sub>BR</sub> Min	I <sub>pp</sub> Max	C <sub>in</sub> Typ
6V	2A	5.3pF

## **Description**

This new generation TVS is designed to protect sensitive electronics from the damage due to ESD. The combination of small size and high ESD surge capability makes it ideal for use in portable applications such as cellular phones, digital cameras, and MP3 players.

### **Applications**

- Cellular Handsets
- Portable Electronics
- · Computers and Peripheral

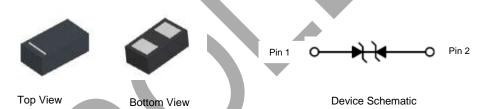
### **Features**

- Provides ESD Protection per IEC 61000-4-2 Standard:
   Air ±19kV, Contact ±17kV
- 1 Channel of ESD Protection
- Low Channel Input Capacitance
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)

### **Mechanical Data**

- Case: X2-ESN0603-2
- Case Material: Molded Plastic, "Green" Molding Compound.
   UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: NiAu Bump. Solderable per MIL-STD-202, Method 208 <sup>@4</sup>
- Weight: 0.0002 grams (Approximate)

### X2-ESN0603-2



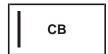
## Ordering Information (Note 4)

Product	Compliance	Marking	Reel Size (inches)	Tape Width (mm)	Quantity per Reel
DESD5V0V1BDLP3-7	Standard	СВ	7	8	10,000/Tape & Reel

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.
- 2. See http://www.diodes.com/quality/lead\_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at http"//www.diodes.com/products/packages.html.

# **Marking Information**



CB = Product Type Marking Code Line Denotes Pin 1



# **Maximum Ratings** (@ $T_A = +25$ °C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit	Conditions
Peak Pulse Power Dissipation	P <sub>PP</sub>	20	W	8/20µs, per Figure 3
Peak Pulse Current	I <sub>PP</sub>	2	Α	8/20µs, per Figure 3
ESD Protection – Contact Discharge	V <sub>ESD_Contact</sub>	±17	kV	IEC 61000-4-2 Standard
ESD Protection – Air Discharge	$V_{ESD\_Air}$	±19	kV	IEC 61000-4-2 Standard
ESD Protection – Human Body Model	V <sub>ESD_HBM</sub>	±10	kV	MIL-STD-883; class 3B

# Thermal Characteristics

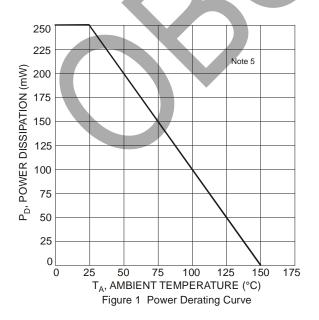
Characteristic	Symbol	Value	Unit
Package Power Dissipation (Note 5)	$P_{D}$	250	mW
Thermal Resistance, Junction to Ambient (Note 5)	R <sub>θJA</sub>	500	°C/W
Operating and Storage Temperature Range	T <sub>J</sub> , T <sub>STG</sub>	-65 to +150	°C

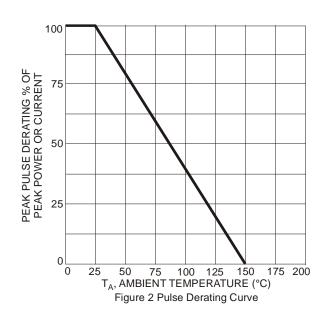
## Electrical Characteristics (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Conditions
Reverse Standoff Voltage	$V_{RWM}$	_	ı	5	V	_
Channel Leakage Current (Note 6)	$I_{RM}$	-	1	100	nA	$V_{RWM} = 5V$
Clamping Valtage Regitive Transients	VcL		J	11.5	V	$I_{PP} = 0.5A, t_p = 8/20\mu S$
Clamping Voltage, Positive Transients		-		12.8		$I_{PP} = 1A, t_p = 8/20\mu S$
Breakdown Voltage	$V_{BR}$	6	<u> </u>	10	V	I <sub>R</sub> = 1mA
Differential Resistance	$R_{DYN}$	_	2.0	_	Ω	TLP, 10A, tp = 100ns
Channel Input Capacitance	C <sub>IN</sub>	4	5.3	6	pF	$V_R = 0V$ , $f = 1MHz$

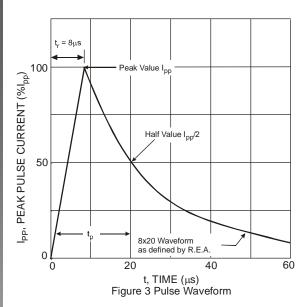
Notes:

- 5. Device mounted on FR-4 PCB pad layout (2oz copper) as shown on Diodes, Inc. suggested pad layout AP02001, which can be found on our website at http://www.diodes.com/datasheets/ap02001.pdf.
  6. Short duration pulse test used to minimize self-heating effect.









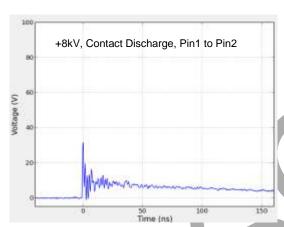
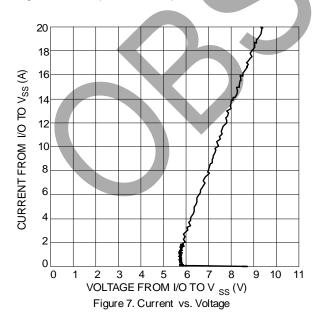


Figure 5. ESD response ESD response to IEC 61000-4-2



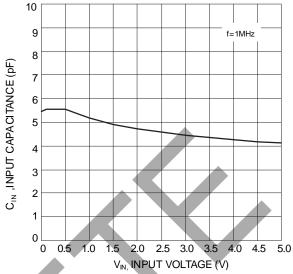


Figure 4. Input Capacitance vs. Input Voltage

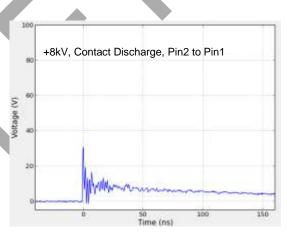


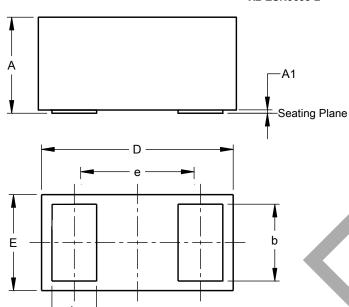
Figure 6. ESD response ESD response to IEC 61000-4-2



## **Package Outline Dimensions**

Please see AP02002 at http://www.diodes.com/datasheets/ap02002.pdf for the latest version.

### X2-ESN0603-2

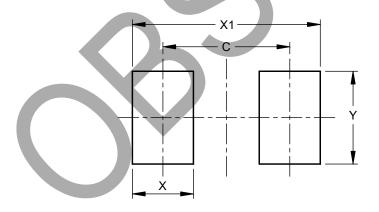


X2-ESN0603-2					
Dim	Min	Max	Тур		
Α	0.28	0.32	0.30		
A1	0.00	0.02	0.01		
b	0.22	0.26	0.24		
D	0.575	0.625	0.600		
Е	0.275	0.325	0.300		
е	_	1	0.395		
L	0.13	0.15	0.14		
All Dimensions in mm					

# **Suggested Pad Layout**

Please see AP02001 at http://www.diodes.com/datasheets/ap02001.pdf for the latest version.

### X2-ESN0603-2



Dimensions	Value (in mm)		
С	0.395		
Х	0.190		
X1	0.580		
Υ	0.290		



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